



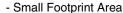
Vishay Siliconix

# P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	$\mathbf{I}_{D}\left(\mathbf{\Omega}\right)$ $\mathbf{I}_{D}\left(\mathbf{A}\right)^{f,g}$ $\mathbf{Q}_{g}$		
- 12	0.060 at V <sub>GS</sub> = - 4.5 V	- 9		
	0.082 at V <sub>GS</sub> = - 2.5 V	- 9	7.15 nC	
	0.114 at V <sub>GS</sub> = - 1.8 V	- 2		

#### **FEATURES**

- · Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-75 Package

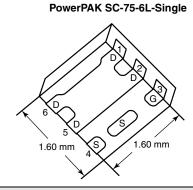


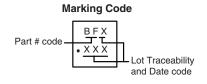


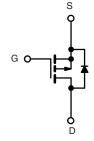
ROHS

### **APPLICATIONS**

 Load Switch, PA Switch and Battery Switch for Portable Devices







Ordering Information: SiB419DK-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 12	v	
Gate-Source Voltage		$V_{GS}$	± 8		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		- 9		
	T <sub>C</sub> = 70 °C	l-	- 9		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 5.2 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 4.2 <sup>a, b</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	- 15		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	- 10.9		
	T <sub>A</sub> = 25 °C	'5	- 2.0 <sup>a, b</sup>		
	T <sub>C</sub> = 25 °C		13.1		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	8.4	w	
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	' Б	2.45 <sup>a, b</sup>	7	
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) <sup>c, d</sup>			260	7	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, e</sup>	t ≤ 5 s	R <sub>thJA</sub>	41	51	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	7.5	9.5		

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 5 s.
- c. See Solder Profile (<a href="http://www.vishay.com/ppg?73257">http://www.vishay.com/ppg?73257</a>). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- e. Maximum under Steady State conditions is 105 °C/W.
- f. Based on  $T_C = 25$  °C.
- g. Package Limited.

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## SiB419DK

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<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}\text{C}$ ,							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	I .,						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$	- 12			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 12.15		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	5 .		5.6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 12 V, V <sub>GS</sub> = 0 V			- 1 μA		
		$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	15			Α	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.2 A		0.049	0.060	Ω	
		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 4.4 A		0.068	0.082		
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.90 A		0.089	0.114	1	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -6 V, I <sub>D</sub> = -5.2 A		11		S	
Dynamic <sup>b</sup>	ľ			'			
Input Capacitance	C <sub>iss</sub>			562		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		175			
Reverse Transfer Capacitance	C <sub>rss</sub>			121			
Total Cata Obayera		$V_{DS} = -6 \text{ V}, V_{GS} = -5 \text{ V}, I_{D} = -5.2 \text{ A}$		7.88	11.82		
Total Gate Charge	Qg			7.15	10.73	nC	
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> = - 9.6 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.2 A		0.94			
Gate-Drain Charge	$Q_{gd}$			1.85			
Gate Resistance	$R_{g}$	f = 1 MHz		7.5		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			16	24		
Rise Time	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, R_{L} = 1.46 \Omega$		42	63		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \simeq -4.1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		28	42	ns	
Fall Time	t <sub>f</sub>			9	13.5	1	
<b>Drain-Source Body Diode Characterist</b>	cs			<u>.                                    </u>			
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 10.9	А	
Pulse Diode Forward Current	I <sub>SM</sub>				15		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 3.2 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			26	39	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			10.4	16	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -3.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		14		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			12			

#### Notes:

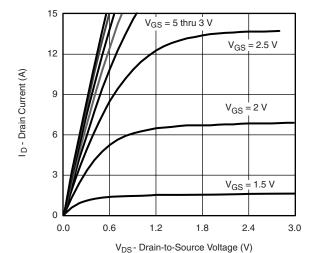
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

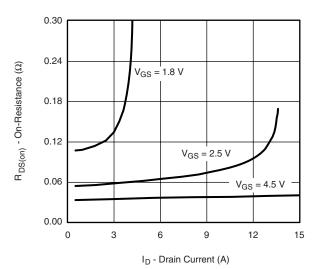


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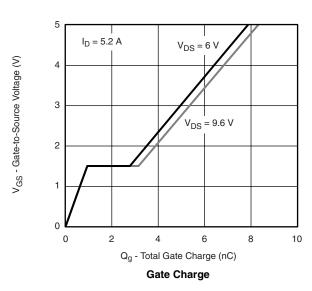
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

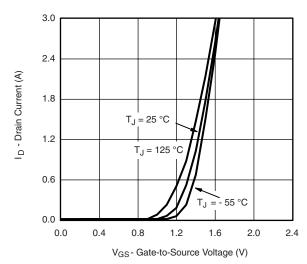


#### **Output Characteristics**

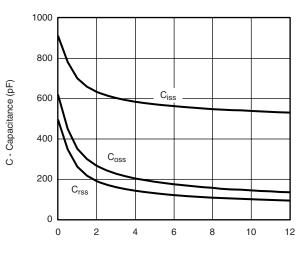


#### On-Resistance vs. Drain Current and Gate Voltage



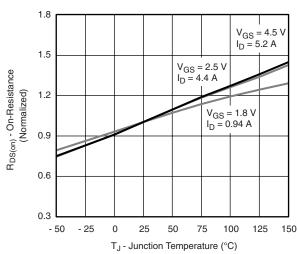


#### **Transfer Characteristics**



V<sub>DS</sub> - Drain-to-Source Voltage (V)





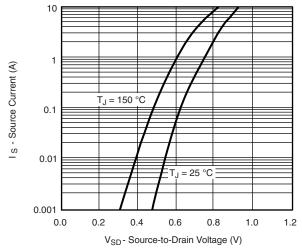
On-Resistance vs. Junction Temperature

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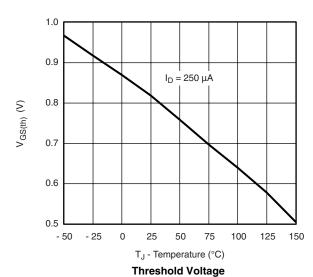
# Vishay Siliconix

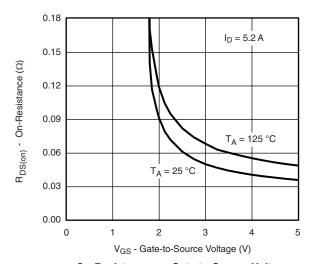
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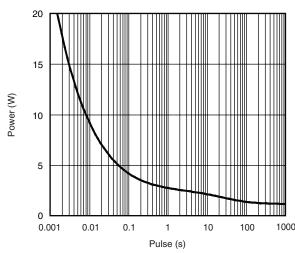


#### Soure-Drain Diode Forward Voltage

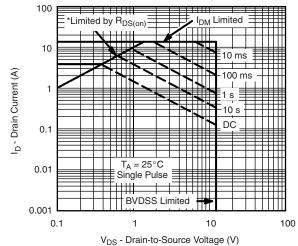




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

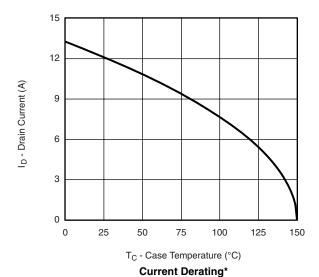
Safe Operating Area, Junction-to-Ambient

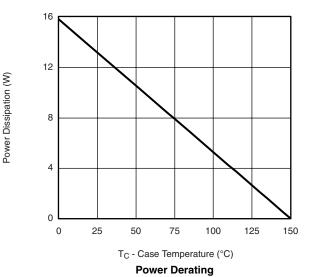


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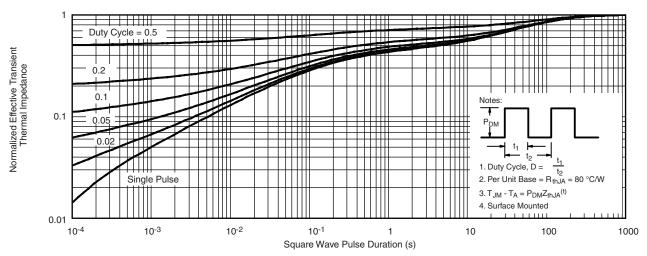
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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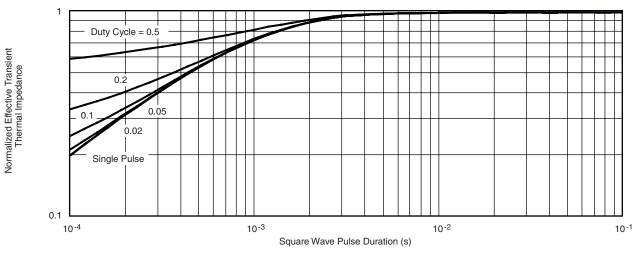
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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